

TAI-SAW TECHNOLOGY CO., LTD.

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Product Specifications Approval Sheet

Product Description:	Crystal Unit SMD 2.	.0x1.6 48.0MHz
TST Part No.: TZ390	8CA4244	
Customer Part No.:_		
Customer signature re	equired	
Company:		
Division:		
Approved by :		
Date:		
Checked by:	Glen Peng	Glen
Approved by:	Kelly Huang	Glen Kuly Huang
Date:	04/26/2022	7

- 1. Customer signed back is required before TST can proceed with sample build and receive orders.
- 2. Orders received without customer signed back will be regarded as agreement on the specifications.
- 3. Any specifications changes must be approved upon by both parties and a new revision of specifications shall be released to reflect the changes.



TAI-SAW TECHNOLOGY CO., LTD. Crystal Unit SMD 2.0x1.6 48.0MHz

MODEL NO.: TZ3908CA4244 REV. NO.: 1

Revise:

1 N/A Initial release 04/26/22' N/A Glen Peng	Rev.	Rev.Page	Rev. Account	Date	Ref. No.	Revised by
	1			04/26/22	N/A	



MODEL NO.: TZ3908CA4244 REV. NO.: 1

Features:

- Surface Mount Hermetic Package
- Excellent Reliability Performance
- Good Frequency Perturbation and Stability over temperature
- Ultra Miniature Package
- AEC-Q200 compliance
- Moisture Sensitivity Level (MSL): Level-1





Description and Applications:

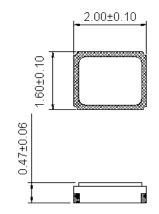
Surface mount 2.0mmx1.6mm crystal unit for use in wireless communications devices, especially for a need of ultra miniature package for mobility.

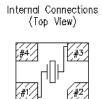
Electrical Specifications:

TZ3908CA4244	Specification
Nominal Frequency	48.000000 MHz
Mode of Oscillation	Fundamental
Storage Temperature Range	-40°C to +125°C
Operating Temperature Range	-40°C to +125°C
Frequency Stability over Operating Temperature Range	+/-20 ppm @ -40°C ~ -30°C +/-15 ppm @ -30°C ~ +85°C +/-40 ppm @ +85°C ~ +105°C +/-80 ppm @ +105°C ~ +125°C (referred to the value at 25°C)
Frequency Make Tolerance (FL)	-6.45+/-5ppm @ 25°C +/- 3°C
Equivalent Series Resistance (ESR)	40 Ω max
Nominal Drive Level	10uW typical and 200uW max
Shunt Capacitance (Co)	0.89 pF typical
Motional Capacitance (C1)	3.39 fF typical
Motional Inductance (L1)	3.24 mH typical
Load Capacitance (CL)	7 pF

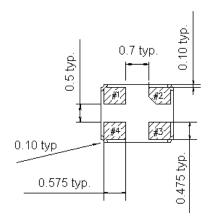
Aging	+/-3 ppm/ year
Insulation Resistance	500 MΩ min./DC 100V
Marking	Laser Marking
Unit Weight	5.7mg+/-0.5mg

Mechanical Dimensions (mm): Base



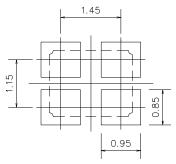


[NOTE] #2, #4 is connected with a metal cover



	Pin connection
#1 Pin	IN/OUT
#2 Pin	GND
#3 Pin	IN/OUT
#4 Pin	GND

Recommended Land Pattern: (unit: mm)

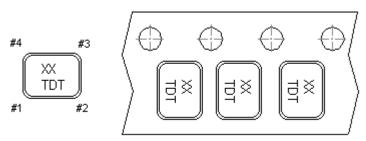


Recommended Land Pattren

Marking:

Line 1: XX; Frequency (48)

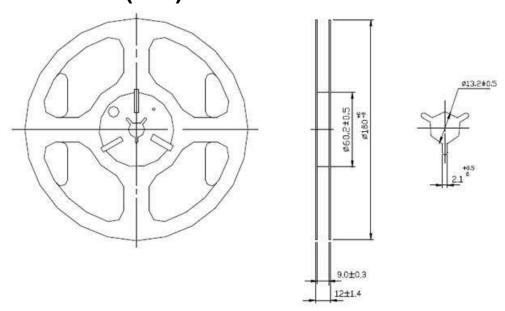
Line 2: T; Traceable Code + D; date Code of Year/Month+ T; Traceability code (1 or no letter)



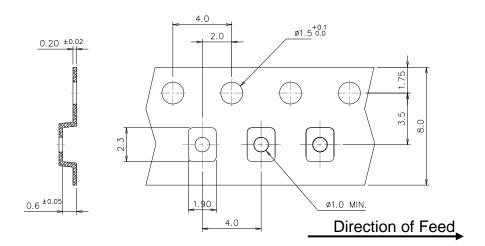
Date Code Table: Year/Month

Year/Month	1	2	3	4	5	6	7	8	9	10	11	12
2022	Α	В	O		Ш	H	O	Ι	J	K	L	М
2023	Ζ	Ρ	Ø	R	ഗ	Τ	\supset	V	W	Х	Υ	Ζ
2024	а	р	O	d	е	f	ත	h	i	j	k	m
2025	n	р	σ	r	Ø	t	3	>	W	×	У	Z
2026	Α	В	O		Ш	H	O	I	J	K	L	М
2027	Z	Ρ	Ø	R	ഗ	Τ	\supset	>	W	Х	Υ	Ζ
2028	а	Ф	U	a	ω	f	පා	h	i	j	k	m
2029	n	р	σ	r	Ø	t	٦	>	W	×	У	Z
2030	Α	В	O		Ш	IL	O	I	J	K	L	М
2031	Z	ш	Ø	R	ഗ	Т	\supset	>	W	X	Υ	Ζ

Reel Dimensions (mm):



Tape Dimensions (mm):

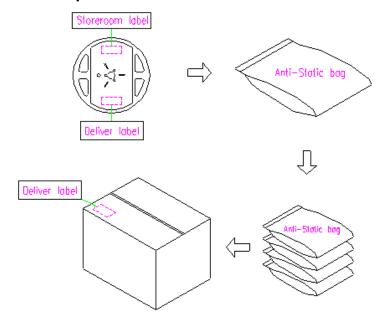


[NOTE]:

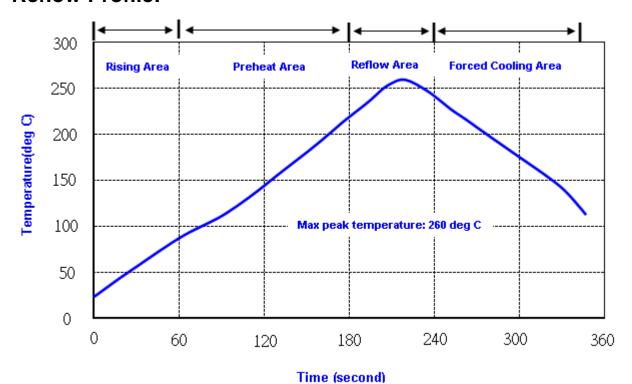
- 1. Unless otherwise specified tolerance on dimension +/-0.1 mm.
- 2. Material: conductive polystyrene with color black.
- 3. 10 pitch cumulative tolerance +/-0.2 mm.

Packing Quantity/Packing:

3K pcs maximum per reel



Reflow Profile:



Note: 1.Max peak temperature: 260+/-5 deg C; Time: 10+/-2 sec

2. Temperature: 217+/-5 deg C; Time: 90~100 sec

Reliability Specifications (AEC-Q200)

Test name	Test process / method	Reference standard						
Mechanical characteristics								
resistance to Soldering heat (IR reflow)	Temp./ Duration: 265°C /10sec ×2 times Total time: 4min.(IR-reflow)	-300(301)M(II)						
Vibration	Total peak amplitude : 1.5mm Vibration frequency : 10 to 2000 Hz Sweep period : 20 minute Vibration directions : 3 mutually perpendicular	MIL-STD 202G method 204						
Mechanical Shock	directions : 3 impacts per axis Acceleration : 6000g's, +20/-0 % Duration : 0.3 ms (total 18 shocks) Waveform : Half-sine	MIL-STD 202G method 213						
Solderability	Solder Temperature:265±5°C Duration time: 5±0.5 seconds.	J-STD-002						
Environmental	characteristics							
Thermal Shock	Heat cycle conditions -55 $^{\circ}$ C (30min) \longleftrightarrow 125 $^{\circ}$ C (30min) * cycle time : 1000 times	MIL-STD 883G method 1010.8						
Humidity test	Temperature : 85 ± 2 °C Relative humidity : 85% Duration : 1000 hours	MIL-STD 202G method 103						
Dry heat (Aging test)	Temperature : 125 ± 2 °C Duration : 1000 hours	MIL-STD 202G method 108A						
Cold resistance (Low Temp Storage)	Temperature : -40 ± 3 °C Duration : 1000 hours	IEC 60068-2-1						